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**Section 1 – Technology Information For ORIS: File Number**

**1A** Technology Title

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Date of Submission

**1B** Submitted By**\*:** Please list ALL PERSON(S) who should be named as Inventors/Creators in any patent filing who made an inventive contribution.

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| **Inventor / Creator** | **Faculty/ Department** | **Principal Residence Address** | **Citizenship** | **Email** | **Percent Contribution** | **Role and Description** |
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For Faculty: Professor, Assistant Professor, Sabbatical Leave, etc.

For Student: Undergraduate, Graduate, Ph.D., Co-op etc.

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| **Co-Inventor(s) / Co-Creator(s)** | **Graduate Student / Undergraduate Student / Other (specify)** | **Principal Residence Address** | **Citizenship** | **Email** | **Percent Contribution\*\*** | **Role and Description** |
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*\* In accordance with the Freedom of Information and Protection of Privacy Act, R.S.O. 1990, c. F 31 (“FIPPA”), the University of Windsor must notify you that we are requesting your personal information. This information may be used when filing for intellectual property protection, particularly patent protection.*

*\*\* The percentage contribution will be used as a guide for future revenue sharing. Revenue distribution is finalized by the parties involved in a technology ownership agreement.*

**1C** Invention Information

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|  | **Date** | **References & Comments** |
| Initial Idea |  |  |
| Conception (first oral or written description of invention) |  |  |
| First reduction to practice |  |  |
| Prototype (a working model available) |  |  |

**1D** Please list several key words/phrases used to categorize this technology.

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**1E** Please provide a detailed description of the technology. Attach a draft manuscript(s), if available.

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**Section 2 – Patent Status**

**2A** Do you intend to file for a patent/IP protection on this technology? **Y/N**

**2B** If yes, do you want to file for the patent/IP protection with the assistance of the University? **Y/N**

**2C** Has a patent search been conducted? **Y/N** *If yes, please attach a copy of the report and the copy of the patent.*

**2D** Has a literature search been conducted? **Y/N** *If yes, please attach the listing and the copies of the papers/publications.*

**2E** Have any patents related to or associated with this technology been previously filed or issued? **Y/N**

*If yes, please attach a copy of the issued patent or the patent application noting the filing date and the selected countries.*

**2F** Are there any other person(s) or organization(s) which have or may have any claims (license rights, options, other intellectual property agreements, etc.) to the technology outside of the university? **Y/N**

*If yes, please list the name(s) of the person(s) or organization(s) and the nature of the claims.*

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| **Name (s)** | **Nature of Claims** |
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**2G** Please list ALL PERSON(S) who should be named as Inventors/Creators in any patent filing.

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| **Name** | **Title** | **Institution** |
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**2H** Has the technology been made and tested? Please explain. (Design, prototype, initial testing etc.)

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**2I** Is this technology built on past technology? **Y/N**

 *If yes, please provide the name(s)/description of the existing technology/technologies contained within this technology.*

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**2J** How is your technology significantly different/novel to from that in the related field?

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**2K** In your opinion, what are the next steps required to develop this technology?

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**2L** What are the potential uses of this technology and the type of work it could be utilized in?

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**2M** What is the likelihood that your technology is obvious to that of a skilled person in the field?

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**Section 3 – Publications/Disclosures**

**3A** Has this technology been previously or pending to be disclosed? **Y/N**

**3B** Has the technology been discussed or disclosed to any other parties (company/individual)? **Y/N**

*If yes, please list the name(s) and the date(s).* *Please also include whether a non-disclosure agreement was signed.*

*Please list and attach copies of any published or pending articles, abstracts, posters, presentations, descriptions etc., including dates, relating to this technology. (Verbal, print or other)*

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| --- | --- | --- | --- |
| **Type** | **Publication** | **Date** | **Non-disclosure agreement signed** |
| Abstract | **Y/N** |  |  |
| Discussion outside of the university | **Y/N** |  |  |
| Manuscript | **Y/N** |  |  |
| Oral Presentation | **Y/N** |  |  |
| Social Platform/Media | **Y/N** |  |  |
| Thesis | **Y/N** |  |  |
| Other parties (Company or Individual) | **Y/N** |  |  |

**Section 4 – Support of Work**

**4A** Please list all of the funding support for the research contributing to this technology.

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| **Funding Source** | **Amount** | **Account Numbers** | **Years** |
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**4B** What equipment or facilities were used in the design and testing of this technology? Please list, including any third parties.

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| **Equipment/facility used** | **Location** | **Contact** |
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**Section 5 – Commercial Assessment**

**5A** What problem does the technology solve? Who would find it useful?

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**5B** How is the problem being addressed now?

*Please list any competing technologies and the name of the competitors, if available.*

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**5C** What is the competitive advantage of this technology over existing technologies?

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**5D** What/who is the target market for this technology?

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**5E** Please provide a description of any ONGOING activities that will facilitate the commercialization of the technology.

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**5F** Have any parties been contacted to discuss commercialization of this technology? **Y/N**

 *If yes, please list the name(s) and the date(s).*

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| **Name (s) and company if applicable** | **Date** |
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**5G** Please provide a description of any FUTURE activities to be undertaken that will facilitate the commercialization of the technology.

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**5H** What are the costs or other impacts of this technological solution to end-users?

*(e.g. will the adoption of this technology require high cost capital equipment or significant changes to current production methods, etc.)*

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**5I** Please list any companies (potential targets) you feel may have an interest in commercializing this technology.

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| **Company** | **Contact** |
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**5J** Please list any government regulations that may impede or drive the acceptance of this technology.

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**5K** Please list any current technical obstacles that need to be addressed prior to commercializing this technology.

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**Section 6 – Formal Declaration (All inventors MUST read the following and sign below)**

Each of the undersigned is a person who has participated in the completion of this form. Each of us further declares to the University of Windsor the following:

As of the date below, I(we) declare that all information contained in this disclosure form; including but not limited to all facts relating to the discovery or technology of the intellectual property stated before in this disclosure form is true, accurate and complete, and have been disclosed by me(us). I(we) also declare that all inventors/creators and participants have been disclosed in this disclosure form by me(us).

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| --- | --- | --- |
| **Inventor/Creator’s Name** | **Inventor/Creator’s Signature** | **Date** |
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